

Vishay High Power Products

Phase Control Thyristors (Hockey PUK Version), 350 A



TO-200AB (A-PUK)

FEATURES

- · Center amplifying gate
- Metal case with ceramic insulator
- International standard case TO-200AB (A-PUK)



• Designed and qualified for industrial level



ROHS

PRODUCT SUMMARY				
I _{T(AV)}	350 A			

TYPICAL APPLICATIONS

- · DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS						
PARAMETER	TEST CONDITIONS	VALUES	UNITS			
1		350	A			
I _{T(AV)}	T _{hs}	55	°C			
1		660	A			
I _{T(RMS)}	T _{hs}	25	°C			
	50 Hz	5000	Α Α			
I _{TSM}	60 Hz	5230	^			
l ² t	50 Hz	125	- kA ² s			
1-1	60 Hz	114	- KA-S			
V _{DRM} /V _{RRM}		400 to 2000	V			
tq	Typical	100	μs			
TJ		- 40 to 125	°C			

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS								
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	$I_{DRM}/I_{RRM} \ MAXIMUM \\ AT \ T_J = T_J \ MAXIMUM \\ mA$				
	04	400	500					
	08	800	900					
ST180CC 12 16 18		1200	1300	30				
		1600	1700	00				
		1800	1900					
	20	2000	2100					

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ST180CPbF Series



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ABSOLUTE MAXIMUM RATIN	GS					
PARAMETER	SYMBOL		TEST CONDITIONS			UNITS
Maximum average on-state current		180° condu	ction, half sine v	vave	350 (140)	Α
at heatsink temperature	I _{T(AV)}	double side	(single side) co	oled	55 (85)	°C
Maximum RMS on-state current	I _{T(RMS)}	DC at 25 °C	heatsink tempe	erature double side cooled	660	
		t = 10 ms	No voltage		5000	
Maximum peak, one-cycle		t = 8.3 ms	reapplied		5230	A kA ² s
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}	Sinusoidal half wave, initial $T_J = T_J$ maximum	4200	
		t = 8.3 ms	reapplied		4400	
Maximum I ² t for fusing	l ² t	t = 10 ms	No voltage reapplied		125	
		t = 8.3 ms			114	
		t = 10 ms			88	
		t = 8.3 ms	reapplied		81	
Maximum I ² √t for fusing	l²√t	t = 0.1 to 10	ms, no voltage	reapplied	1250	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$(16.7 \% x \pi x I_{T(AV)} < I < \pi x I_{T(AV)}), T_J = T_J \text{ maximum}$			V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			1.14	ľ
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)} < I < \pi$ x $I_{T(AV)}$), $T_J = T_J$ maximum			1.18	m 0
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$			1.14	mΩ
Maximum on-state voltage	V_{TM}	$I_{pk} = 750 \text{ A}, T_J = T_J \text{ maximum}, t_p = 10 \text{ ms sine pulse}$			1.96	٧
Maximum holding current	I _H	T _ 05 °C			600	mA
Maximum (typical) latching current	ΙL	$T_J = 25$ °C, anode supply 12 V resistive load 1000 (300			1000 (300)	IIIA

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dI/dt	Gate drive 20 V, 20 Ω , $t_r \le 1~\mu s$ $T_J = T_J$ maximum, anode voltage $\le 80~\%$ V_{DRM}	1000	A/µs
Typical delay time	t _d	Gate current 1 A, $dl_g/dt = 1$ A/ μ s $V_d = 0.67 \% V_{DRM}$, $T_J = 25 °C$	1.0	- 10
Typical turn-off time	tq	$I_{TM}=300~A,~T_J=T_J~maximum,~dl/dt=20~A/\mu s, \\ V_R=50~V,~dV/dt=20~V/\mu s,~gate~0~V~100~\Omega,~t_p=500~\mu s$	100	μs

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	dV/dt	$T_J = T_J$ maximum linear to 80 % rated V_{DRM}	500	V/µs
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	$T_J = T_J$ maximum, rated V_{DRM}/V_{RRM} applied	30	mA



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TRIGGERING						
DADAMETER	CVMDOL	TEGT COURTIONS			VALUES	
PARAMETER	SYMBOL	'	TEST CONDITIONS	TYP.	MAX.	UNITS
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum,	, t _p ≤ 5 ms	10		w
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum,	f = 50 Hz, d% = 50	2	.0	l vv
Maximum peak positive gate current	I _{GM}			3	.0	Α
Maximum peak positive gate voltage	+ V _{GM}	$T_J = T_J$ maximum, $t_p \le 5$ ms		20	V	
Maximum peak negative gate voltage	- V _{GM}]		5.0		7
	I _{GT}	T _J = - 40 °C	Maximum required gate trigger/	180	-	
DC gate current required to trigger		T _J = 25 °C		90	150	mA
		T _J = 125 °C	current/voltage are the lowest value	40	-	
		T _J = - 40 °C which will trigger all units 12 V	2.9	-		
DC gate voltage required to trigger	V _{GT}	T _J = 25 °C	anode to cathode applied	1.8	3.0	V
	T _J = 125 °C			1.2	-	
DC gate current not to trigger	I _{GD}	T _ T movimum	Maximum gate current/voltage not to trigger is the maximum value	10		mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J \text{ maximum}$	which will not trigger any unit with rated V _{DRM} anode to cathode applied	0.25		V

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		UNITS		
Maximum operating junction temperature range	TJ		- 40 to 125	°C		
Maximum storage temperature range	T _{Stg}		- 40 to 150			
Maximum thermal resistance,	R _{thJ-hs}	DC operation single side cooled	0.17			
junction to heatsink	□thJ-hs	DC operation double side cooled	0.08	K/W		
Maximum thermal resistance,	D	DC operation single side cooled	0.033	IV VV		
case to heatsink	R _{thC-hs}	DC operation double side cooled	0.017			
Mounting force, ± 10 %			4900 (500)	N (kg)		
Approximate weight			50	g		
Case style		See dimensions - link at the end of datasheet TO-200AB (A		A-PUK)		

△R _{thJC} CONDUCTION								
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION		CONDUCTION		TEST CONDITIONS	UNITS		
	SINGLE SIDE	DOUBLE SIDE	SINGLE SIDE	DOUBLE SIDE				
180°	0.015	0.015	0.011	0.011	T _J = T _J maximum			
120°	0.018	0.019	0.019	0.019				
90°	0.024	0.024	0.026	0.026		K/W		
60°	0.035	0.035	0.036	0.037				
30°	0.060	0.060	0.060	0.061				

Note

[•] The table above shows the increment of thermal resistance RthJC when devices operate at different conduction angles than DC

Vishay High Power Products Phase Control Thyristors (Hockey PUK Version), 350 A



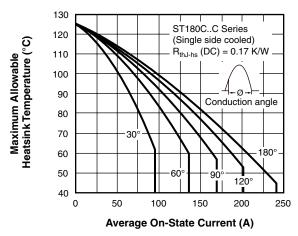
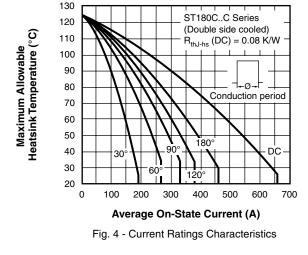


Fig. 1 - Current Ratings Characteristics



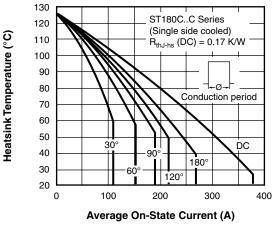


Fig. 2 - Current Ratings Characteristics

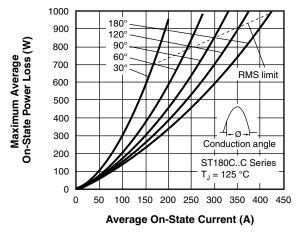


Fig. 5 - On-State Power Loss Characteristics

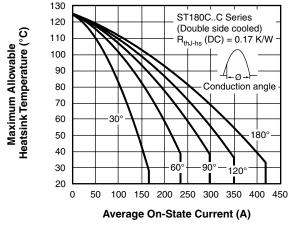


Fig. 3 - Current Ratings Characteristics

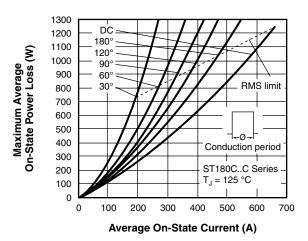


Fig. 6 - On-State Power Loss Characteristics

Maximum Allowable



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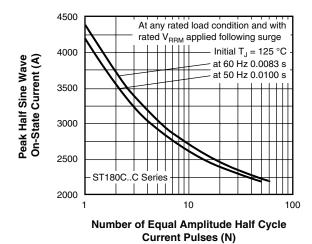


Fig. 7 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

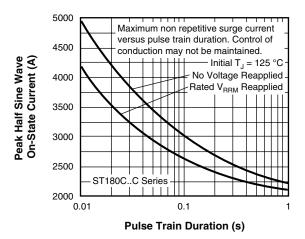


Fig. 8 - Maximum Non-Repetitive Surge Current Single and Double Side Cooled

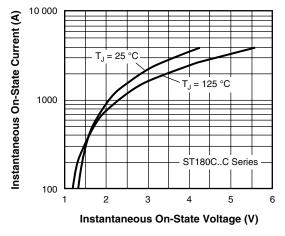


Fig. 9 - On-State Voltage Drop Characteristics

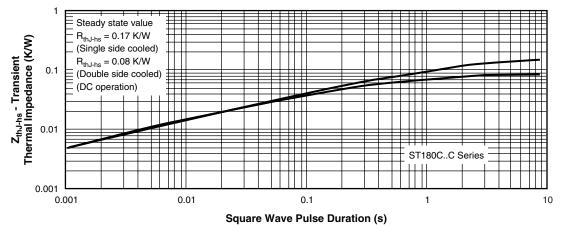


Fig. 10 - Thermal Impedance $Z_{thJ\text{-}hs}$ Characteristics

Document Number: 94396 Revision: 11-Aug-08

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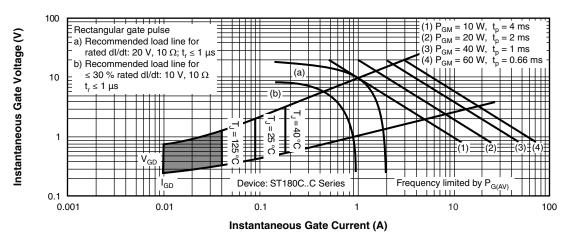
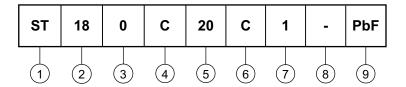


Fig. 11 - Gate Characteristics

ORDERING INFORMATION TABLE

Device code



1 - Thyristor

2 - Essential part number

3 - 0 = Converter grade

4 - C = Ceramic PUK

5 - Voltage code x 100 = V_{RRM} (see Voltage Ratings table)

6 - C = PUK case TO-200AB (A-PUK)

7 - 0 = Eyelet terminals (gate and auxiliary cathode unsoldered leads)

1 = Fast-on terminals (gate and auxiliary cathode unsoldered leads)

2 = Eyelet terminals (gate and auxiliary cathode soldered leads)

3 = Fast-on terminals (gate and auxiliary cathode soldered leads)

8 - Critical dV/dt: • None = 500 V/µs (standard selection)

• L = 1000 V/µs (special selection)

9 - Lead (Pb)-free

LINKS TO RELATED DOCUMENTS			
Dimensions	http://www.vishay.com/doc?95074		



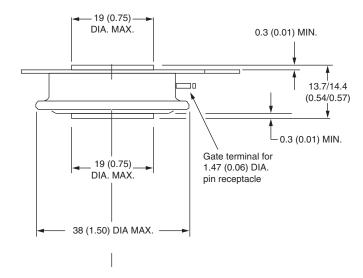
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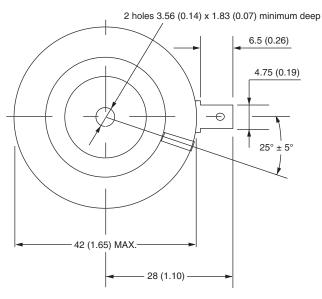
TO-200AB (A-PUK)

DIMENSIONS in millimeters (inches)

Anode to gate

Creepage distance: 7.62 (0.30) minimum Strike distance: 7.12 (0.28) minimum





Quote between upper and lower pole pieces has to be considered after application of mounting force (see thermal and mechanical specification)



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